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Received: 21 January 2016 Accepted: 22 March 2016 Published: 12 April 2016

Inhibition of unintentional extra carriers by Mn valence change for high insulating devices

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For intrinsic oxide semiconductors, oxygen vacancies served as the electron donors have long been, and inevitably still are, attributed as the primary cause of conductivity, making oxide semiconductors seem hard to act as high insulating materials. Meanwhile, the presence of oxygen vacancies often leads to a persistent photoconductivity phenomenon which is not conducive to the practical use in the fast photoelectric response devices. Herein, we propose a possible way to reduce the influence of oxygen vacancies by introducing a valence change doping in the monoclinic β -Ga₂O₃ epitaxial thin film. The unintentional extra electrons induced by oxygen vacancies can be strongly suppressed by the change valence of the doped Mn ions from +3 to +2. The resistance for the Mn-doped Ga₂O₃ increases two orders of magnitude in compared with the pure Ga₂O₃. As a result, photodetector based on Mn-doped Ga₂O₃ thin films takes on a lower dark current, a higher sensitivity, and a faster photoresponse time, exhibiting a promising candidate using in high performance solar-blind photodetector. The study presents that the intentional doping of Mn may provide a convenient and reliable method of obtaining high insulating thin film in oxide semiconductor for the application of specific device.

The intrinsic semiconductors always exhibit unintentional n- or p- type conductivity induced by native defects such as vacancies or interstitials^{1,2}, leading to a difficulty in achieving high insulating material and limiting their use in the specific devices such as photodetector, dielectric layer, etc. In particular, for oxide semiconductors, the conductivity is often seen to exhibit a pronounced dependence on partial pressure of oxygen during growth^{3,4}. It seems logical, that this conductivity is related to the presence of oxygen vacancies which served as the electron donors leading to a decrease in resistivity, as has been assumed for many years. In fact, with recent advances in growth techniques, particularly perhaps the advent of novel schemes of molecular beam epitaxy, it has become possible to grow thin films of oxide materials, as required for device applications, with rather high structural quality⁵⁻⁷. Notwithstanding this, however, oxygen vacancies have long been⁶⁻⁸, commonly and inevitably still are, attributed as the primary cause of conductivity in oxide semiconductors. Meanwhile, the presence of oxygen vacancies in oxides often leads to a persistent photoconductivity phenomenon since the carriers trapped by oxygen vacancies have longer lifetime and drift back to their original states slowly^{9,10}. It is not conducive to the practical use in the fast photoelectric response devices. Take ZnO based photodetector as an example, the response time would extend to the order of minutes or hours due to the presence of oxygen vacancies^{9,10}. In this work, we propose a possible way to suppress the unintentional extra carriers which are induced by oxygen vacancies and reduce the influence of oxygen vacancies by introducing a valence change Mn element doping, with a recent hot wide band gap semiconductor material — β -gallium oxide (Ga₂O₃) using for solar-blind photodetector as an

 β -Ga₂O₃, with ~4.9 eV direct band gap and tunable by alloying with Al₂O₃ or In₂O₃, is particularly suitable for the deep ultraviolet (DUV) photodetector that is blind to wavelengths above 280 nm, which has a vast and ever growing number of military and civil surveillance applications such as missile tracking, fire detection, ozone holes monitoring, chemical/biological analysis, and so on^{11–13}. The solar-blind photodetector could detect very weak signals accurately due to the "black background" with the absence of wavelength shorter than 280 nm in

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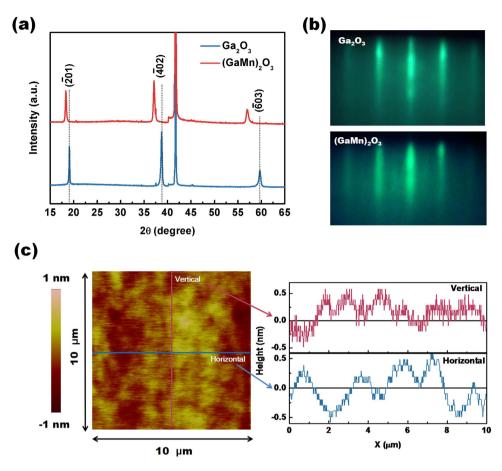


Figure 1. θ -2θ XRD patterns (**a**) and RHEED patterns (**b**) of the β -Ga₂O₃ and (GaMn)₂O₃ epitaxial thin films; (**c**) Surface morphology of the β -Ga₂O₃ epitaxial thin film.

solar radiation and artificial lighting. During the past decade, solar-blind photodetectors based on wide band gap semiconductors such as AlGaN, ZnMgO, and diamond, β -Ga₂O₃ have attracted intensive attentions^{11,12,14,15}. But high quality epitaxial AlGaN film is difficult to be prepared due to high growth temperature, single wurtzite phase ZnMgO and diamond are not possible to be used to detect entire deep ultraviolet region due to their mismatched band gaps^{11,12}. On the other hand, β -Ga₂O₃ has great thermal and chemical stability, determining its possibility of working at high temperatures and being unaffected even by concentrated acids such as hydrofluoric acid^{16,17}. Therefore, relatively, β -Ga₂O₃ is considered as one of the most ideal candidates to fabricate solar-blind photodetector. In our previous work, high epitaxial β -Ga₂O₃ thin films have been grown via laser molecular beam epitaxy (LMBE) and fabricated metal-semiconductor-metal (MSM) structure using for photodetector, showing an obvious DUV solar-blind photoelectric properties^{12,18}. At the same time, we also note that oxygen vacancies widely exist inside the gallium oxide thin films and have a significant impact on the photoelectric performance^{12,19,20}. Based on the above, β -Ga₂O₃ epitaxial thin film using for solar-blind photodetector is an ideal candidate for studying the influence of oxygen vacancies and the suppression of unintentional extra carriers which are induced by oxygen vacancies.

Results and Discussion

Both the undoped and Mn-doped β -Ga₂O₃ [(GaMn)₂O₃] epitaxial thin films were grown on α -Al₂O₃ (0001) substrate using the LMBE technique, and (GaMn)₂O₃ was obtained by alternately depositing Ga₂O₃ and Mn thin layers. For both the Ga₂O₃ and (GaMn)₂O₃ thin film, only the ($\overline{2}$ 01) peak and higher order peaks of Ga₂O₃ monoclinic β phase are presented besides those from the substrate, which indicates that the films are grown with a preferred ($\overline{2}$ 01) plane orientation [Fig. 1(a)]. For the (GaMn)₂O₃ thin film, the positions of these peaks shift to lower 2 θ compared to the undoped Ga₂O₃ thin film. The shift in the 2 θ values indicates an increase of the lattice constants, which can be attributed to the ionic radii difference between Mn and Ga (Mn²⁺, Mn³⁺ and Ga³⁺ ionic radii are 0.83, 0.64 and 0.62 Å, respectively)^{21,22}. The Mn doping concentration was determined as 28.4 at.% by the X-ray photoelectron spectroscopy (XPS) in the (GaMn)₂O₃ thin film. The clear and streaky reflection high-energy electron diffraction (RHEED) patterns suggest that the Ga₂O₃ and (GaMn)₂O₃ thin films are of single phase with very smooth surfaces [Fig. 1(b)]. The mean surface roughness of the Ga₂O₃ epitaxial thin film is 0.239 nm over $10 \times 10 \, \mu \text{m}^2$ scanning area [Fig. 1(c)]. Both the Ga₂O₃ and (GaMn)₂O₃ thin films have uniform and similar thickness of about 100 nm. Figure 2(a) shows the low-magnification bright-field transmission electron microscope (TEM) image of the (GaMn)₂O₃ thin film growth on Al₂O₃ substrate. The elemental composition mapping of

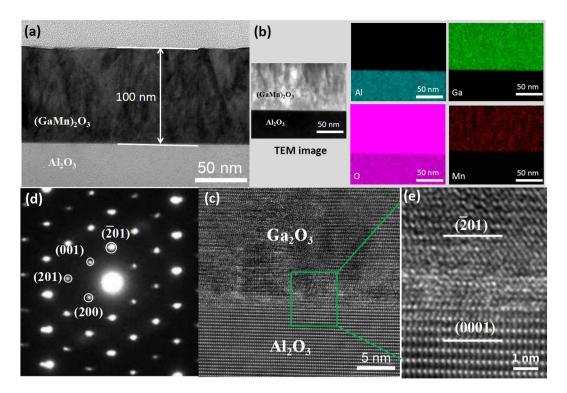


Figure 2. (a) Cross-sectional low-magnification TEM bright-field image of the $(GaMn)_2O_3/Al_2O_3$ interface; (b) TEM-EDX measurement of cross-sectional observation image of the $(GaMn)_2O_3/Al_2O_3$ interface, and the composition distributions of Al, Ga, O, and Mn elements drew by different colors; (c) Cross-sectional HRTEM image of the Ga_2O_3/Al_2O_3 interface; (d) Selected-area electron-diffraction patterns of Ga_2O_3 thin film obtained along [010] aixs; (e) High-magnification HRTEM image taken from the Ga_2O_3/Al_2O_3 interface as marked by a green small pane in (c).

cross-sectional observation of the $(GaMn)_2O_3/Al_2O_3$ interface was obtained to investigate the composition distributions in the $(GaMn)_2O_3$ thin film [Fig. 2(b)]. From the analysis results, Ga and Mn metals are distributed uniformly in the film and there are no noticeable phase separating areas. The cross-sectional elemental mapping was conducted over 10 places; thereby no clear separated phase or metal agglomerated areas were confirmed. It is consistent with the secondary ion mass spectrometry (SIMS) depth profiling in our previous report²³, indicating that Mn is actually uniformly distributed. The interface microstructure between the Ga_2O_3 film and the Al_2O_3 substrate were also explored [Fig. 2(c)]. β phase of Ga_2O_3 has been further confirmed by the selected-area electron diffraction patterns of Ga_2O_3 thin film along [010] aixs [Fig. 2(d)]²⁴. The high-resolution transmission electron microscope (HRTEM) image shows a sharp interface of the Ga_2O_3 and Al_2O_3 without any precipitation [Fig. 2(e)]. Meanwhile, it clearly indicates the orientation relationship of ($\overline{2}01$) β - Ga_2O_3 //(0001) Al_2O_3 and confirms the epitaxial growth of the film. More detailed epitaxial relationship between ($\overline{2}01$) β - Ga_2O_3 and (0001) Al_2O_3 was described in the Supplementary Information.

To construct a MSM photodetector, radio frequency magnetron sputtering technique was used to deposit four pairs of Au/Ti interdigital electrode on the epitaxial thin films using a shadow mask [Supplementary Fig. S1]. Figures 3(a) and 4(a) show the fresh dark current-voltage (I-V) characteristic curves of the Ga₂O₃ and (GaMn)₂O₃ thin films based MSM photodetectors respectively. For the Ga₂O₃ thin film, the *I-V* curve is linear with a large resistance of 12.5 GΩ. The fresh dark current is about 0.8 nA at the voltage of 10 V [Fig. 3(a)]. While for the $(GaMn)_2O_3$ thin film, the fresh dark current increases quickly from 0 V to 1.3 V (-1.3 V) and then increase slightly as the voltage continually increases to 10 V (-10 V), exhibiting an nonlinear behavior [Fig. 4(a)]. When the photodetectors are exposed to the 254 nm light, the slopes of I-V curves show a sharp increase for both the Ga₂O₃ and (GaMn)₂O₃ thin films [Figs 3(b) and 4(b)]. Meanwhile, the photocurrent increases with the increase of the light intensity. However, when the illumination turns off, the decay process of photocurrent is different for the two devices. The consecutive sweeps of dark I-V curves of the Ga_2O_3 photodetector after the 254 nm light turns off is shown in Fig. 3(c), and the change of sweep voltage is depicted in the inset. The current vs voltage decreases quickly during the several initial I-V sweeps and then decrease slightly. Nevertheless, the tiny fresh dark current cannot be obtained again. The dark current is about 120 nA at the voltage of 10 V after turning off the 254 nm light for 24 hours, which increases by about 150 times compared to the fresh dark current [Supplementary Fig. S2]. For the (GaMn)₂O₃ photodetector, the dark current can back to the original value in the half circle of the first *I-V* sweep [Fig. 4(c)]. The final dark current after 254 nm illumination is about 1.2 nA at the voltage of 10 V.

To further evaluate the performance of the Ga_2O_3 and $(GaMn)_2O_3$ photodetectors comparatively, the time-dependent photoresponse to DUV illumination were investigated. Figure 5(a,b) show the time-dependent photoresponse of the Ga_2O_3 and $(GaMn)_2O_3$ photodetectors to 254 nm UV light illumination with varied optical

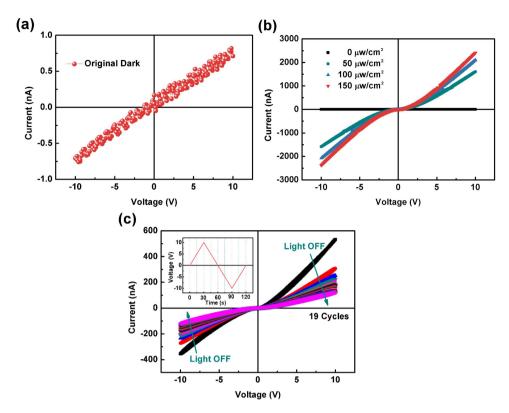


Figure 3. (a) the fresh dark I-V characteristic curve of the Ga_2O_3 photodetector; (b) I-V curves of the Ga_2O_3 photodetector in dark and under 254 nm light with varied optical input power; (c) the consecutive sweeps of I-V curves of the Ga_2O_3 photodetector when the illumination turns off, and the change of sweep voltage is depicted in the upper left inset.

input power (50, 100, 150 μ W/cm²) by on/off switching at 10 V respectively. The illumination current increases with increasing incident optical power. For example, for the Ga_2O_3 photodetector, the illumination current is 1531.2, 2018.1, and 2490.6 nA for the optical power of 50, 100, and 150 μ W/cm², respectively. Meanwhile, for the fixed optical power, both the illumination and dark currents increase with the increase of applied bias [Supplementary Fig. S3(a,b)]. However, there are also some obvious differences between two devices. For the Ga_2O_3 photodetector, the current increases from approximately 465.6 nA of original dark current to a non-stable value of approximately 2490.6 nA of illumination current with an optical input power of 150 μ W/cm² at 10 V [Fig. 5(a)]. However, the recovery time is extremely long after the light is turned off. Such slow recovery should be attributed to the electron-hole trapping states, which would prevent charge-carrier recombination. And the original dark current cannot be obtained with a duration time of 20 s after turning off the 254 nm light. For the (GaMn)₂O₃ photodetector, the dark current is approximately 3.1 nA at 10 V, which is low and favorable for practical detectors. Under 254 nm light with an optical input power of 150 μ W/cm² illuminations, the current instantaneously increases to a stable value of approximately 238.5 nA. When the light turns off, the current decreases rapidly down to 3.5 nA, which is quite close to the initial dark value.

The sensitivity, the spectra responsivity (R_{λ}) and the external quantum efficiency (EQE) are the key parameters to evaluate the performance of a photodetector (the definition of these parameters please see Supplementary Information)^{25–27}. The larger values of sensitivity, R_{λ} and EQE – the higher performance a photodetector has. These the parameters for our two photodetectors are listed in Table 1. The sensitivity increases with the increase of incident optical power, while it increases firstly and then decreases with increasing applied bias [Fig. 5(e,f)]. Meanwhile, the R_{λ} and EQE values increase with the increase of applied bias while decrease with increasing incident optical power. The sensitivity of the $(GaMn)_2O_3$ photodetector is significant superior to that of the Ga_2O_3 photodetector due to its tiny dark current. The maximum sensitivity of 67.1 was obtained at 10 V with an optical input power of 150 μ W/cm² in the $(GaMn)_2O_3$ photodetector. The band gap for 28.4 at.% Mn doping Ga_2O_3 thin film can be estimated to about 4.75 eV, which has a bit red shift compared to undoped Ga_2O_3 (4.92 eV)²³. The light absorption to 254 nm UV light for undoped Ga_2O_3 thin film is a bit stronger than Mn-doped one, which contributes to a higher sensitivity. However, the Ga_2O_3 photodetector exhibits the bigger R_{λ} and EQE values than the $(GaMn)_2O_3$ photodetector. Herein, the maximum R_{λ} value of 1.30 A/W was obtained at 20 V with an optical input power of 150 μ W/cm² in the Ga_2O_3 photodetector, which corresponds to an $EQE \sim 634\%$.

Another important parameter for UV photodector is response time. A bi-exponential relaxation equation was used to analyze quantitatively the current rise and decay process of two devices (please see Supplementary Information). As shown in Fig. 5(c,d) and [Supplementary Fig. S3(c,d)], the photoresponse processes are well fitted. τ_r and τ_d are the time constants for the rise edge and decay edges respectively. We note that both the current

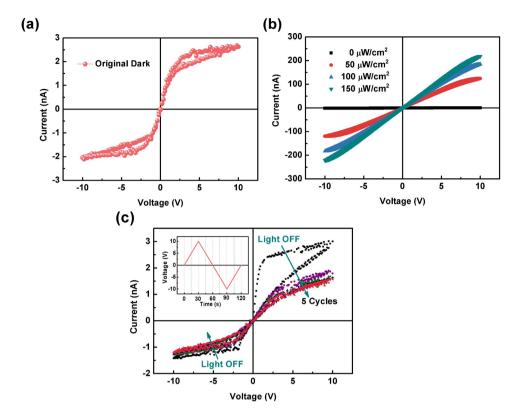


Figure 4. (a) the fresh dark I-V characteristic curve of the $(GaMn)_2O_3$ photodetector; (b) I-V curves of the $(GaMn)_2O_3$ photodetector in dark and under 254 nm light with varied optical input power; (c) the consecutive sweeps of I-V curves of the $(GaMn)_2O_3$ photodetector when the illumination turns off, and the change of sweep voltage is depicted in the upper left inset.

rise and decay processes consist of two components with a fast-response component and a slow-response component for the Ga_2O_3 photodetector, while there is only a fast-response component for the $(GaMn)_2O_3$ photodetector. Generally, the fast-response component can be attributed to the rapid change of carrier concentration as soon as the light is turned on/off, while the slow-response component is caused by the carrier trapping/releasing owing to the existence of defects in $\beta\text{-}Ga_2O_3$ thin films such as oxygen vacancies. For example, for the 254 nm illumination with an optical input power of $150\,\mu\text{W/cm}^2$ at $10\,\text{V}$, the decay process is rapid with a τ_d of 0.28 s for the $(GaMn)_2O_3$ photodetector, while the decay process of the Ga_2O_3 photodetector is slow which consists of two components ($\tau_{d1}=0.47$ s, $\tau_{d2}=6.87$ s). The $(GaMn)_2O_3$ photodetector presents a much faster response speed to light than that of the Ga_2O_3 photodetector.

To understand the impact of the Mn dopants on the conducting properties, the crystal structure was built [Fig. 6(a)]²⁸, and the electronic structure was calculated with density functional theory (DFT). Figure 6(b,c) shows the electronic structure of undoped and Mn-doped β -Ga₂O₃ respectively. The Fermi level was set at zero-point of energy. For the calculation of band structure of undoped β -Ga₂O₃, a 1 × 2 × 1 supercell doubling the monoclinic unit along the b direction was modeled. The calculated width of the band gap is 2.068 eV (uncorrected), which is less than half the experimental value of 4.9 eV. This is because DFT theory is based on the ground state theoretically, resulting in that the exchange-correlation potential between the excited electronic has been underestimated. Before the calculation of band structure of Mn-doped β -Ga₂O₃, the site occupancy of the Mn dopants was investigated by the total energy density functional theory calculation. With the Mn doping concentration of 28.4 at.%, two Mn ions replacing with two Ga ions in a conventional unit cell with a dopant concentration of 25 at.% was modeled. Comparing the total energy, those two Mn ions substituting two adjacent octahedral sites is found energetically stable, and the electronic band structure is given in Fig. 6(c). Relative to undoped β-Ga₂O₃, there are six new bands within the band gap occupying energies. For the neutral cell, which corresponds to 3+ valence for the Mn, two thirds of these new states are occupied, and the other unoccupied; that is, the Fermi level is located in these defect states. Mn3+ is amphoteric since it can accept and donate an electron if the Fermi level crosses the Mn²⁺/Mn³⁺ acceptor or the Mn³⁺/Mn⁴⁺ donor level^{29,30}. In our previous report, two valence states of Mn ions (Mn²⁺/Mn³⁺) were observed in our (GaMn)₂O₃ thin films by using XPS²³. Therefore, the Fermi level should be located within kT of the Mn²⁺/Mn³⁺ transition level, which is depicted schematically in Fig. 6(c). In this model, if the Fermi level is higher, additional electrons would enter the Mn d-shell, and thus decreasing the valence to $2+^{29-31}$. In other words, if Mn doping is the dominant defect in β -Ga₂O₃, the Fermi level will be pinned close to the Mn²⁺/Mn³⁺ transfer level. In our undoped β -Ga₂O₃ thin film, oxygen vacancies always existed as the donor-type defects²³, attributed as the primary origin of intrinsic n-type conductivity. For the Mn doping, the extra electrons introduced by oxygen vacancies would enter the Mn d-shell, and the neutral acceptors (Mn³⁺) are

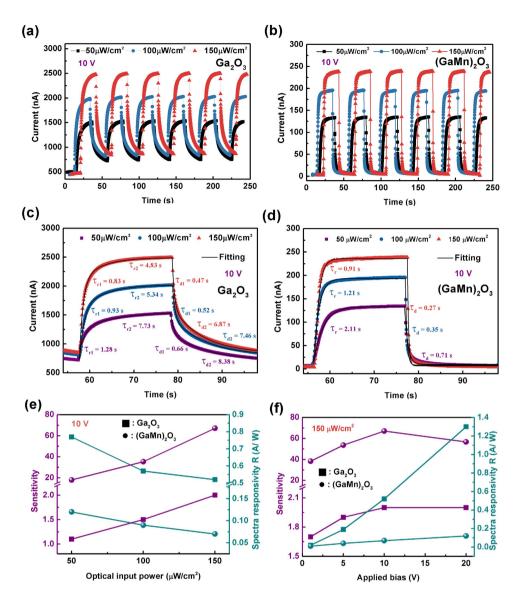


Figure 5. Time-dependent photoresponse of the Ga_2O_3 (a) and $(GaMn)_2O_3$ (b) photodetectors to 254 nm UV light illumination with varied optical input power (50, 100, 150 μ W/cm²) by on/off switching at 10 V, and (c,d) are the corresponding fitted curve for the current rise and decay process of (a,b) respectively. The sensitivity and spectra responsivity (R) of the photodetectors with varied optical input power (e) and varied applied bias (f).

converted to negatively charged acceptors (Mn^{2+}). The change of Mn valence suppresses the unintentional extra carriers, and the Mn ion acts as the "carrier killer". Therefore, the (GaMn)₂O₃ thin film has a higher resistivity compared to the undoped Ga_2O_3 , leading to a lower dark current in the application of photodetector. At the same time, the oxygen vacancies are usually acted as the carrier trapping/releasing centers in the photodetector. Under the illumination of 254 nm light, some of the photogenerated carriers are captured by the trapping states of oxygen vacancies. When the illumination is turned off, these carriers captured by the oxygen vacancies would be released and recombined. Generally, traps in a wide band gap semiconductor are extremely deep. The time constant of the transient decay is governed by the depth of these traps and can be very long, and this process is responsible for the slow-response component. For the as-grown undoped Ga_2O_3 thin films, the II peak of O 1s XPS which is usually associated with the oxygen vacancy is obvious²³. While for the (GaMn)₂O₃ thin film, the II peak of O 1s is highly suppressed, indicating that the oxygen vacancy concentration decreased markedly [Supplementary Fig. S4]. The presence of many oxygen vacancies prevents carriers' recombination and causes the slow recovery time for pure β - Ga_2O_3 thin film. And the reduction of oxygen vacancies concentration by Mn doping contributes to a faster response speed to light for $(GaMn)_2O_3$ photodetector.

In conclusion, we propose a possible way to suppress the unintentional extra carriers and reduce the influence of oxygen vacancies in β -Ga₂O₃ thin film by introducing a valence change element Mn doping. The high insulating monoclinic β -Ga₂O₃ epitaxial thin film has been achieved on α -Al₂O₃ (0001) substrate by Mn-doping through alternately depositing Ga₂O₃ and Mn thin layers using the LMBE technique. The experimental results indicate that Mn ions uniformly distributed in the thin film and replaced Ga sites with an expansion of the crystal

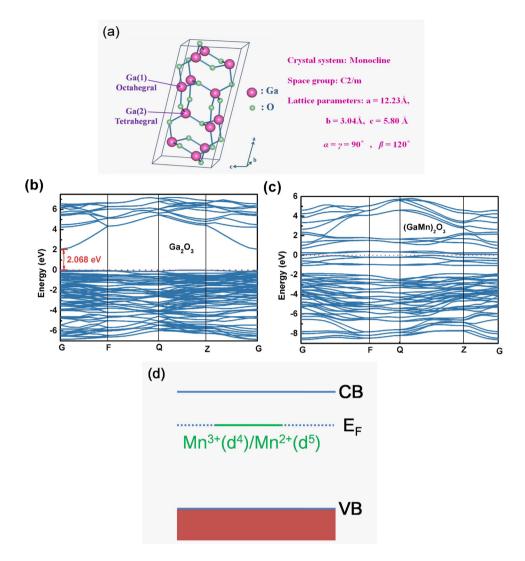


Figure 6. (a) The conventional unit cell of monoclinic β -Ga₂O₃; Band structure plots of pure β -Ga₂O₃ (b) and Mn replacing two adjacent octahedral sites in an conventional unit cell with a dopant concentration of 25% (**c**,**d**) Schematic diagram showing mid-gap Fermi level near the Mn²⁺/Mn³⁺ transition level.

		${ m Ga_2O_3}$									(GaMn)₂O₃						
		Sensitivity $(I_p/I_d, I_p = I_{il} - I_d)$; Spectra responsivity $(R_\lambda = I_p/PS)$; External quantum efficiency $(EQE = hcR_\lambda/e\lambda)$					Response time (au)				Sensitivity(I_p/I_d , $I_p = I_{il} - I_d$); Spectra responsivity($R_\lambda = I_0/PS$); External quantum					au	
							$ au_r(s)$		$ au_d(extsf{s})$		efficiency ($EQE = hcR_{\lambda}/e\lambda$)					$ au_r(\mathbf{s})$	$ au_d(s)$
		$I_d(nA)$	I _{il} (nA)	I_p/I_d	R (A/W)	EQE (%)	$ au_{r1}$	$ au_{r2}$	$ au_{d1}$	$ au_{d2}$	$I_d(nA)$	I _{il} (nA)	I_p/I_d	R (A/W)	EQE (%)	$ au_r$	$ au_d$
	50 μW/cm ²	721.3	1531.2	1.1	0.77	376	1.28	7.73	0.66	8.38	7.1	134.4	17.9	0.12	59	0.71	2.11
	100 μW/cm ²	808.8	2018.1	1.5	0.57	278	0.93	5.34	0.52	7.46	5.4	195.8	35.3	0.09	44	1.21	0.35
	150 μW/cm ²	842.1	2490.6	2.0	0.52	254	0.83	4.83	0.47	6.87	3.5	238.5	67.1	0.07	36	0.91	0.28
150 μW/cm ²	1 V	28.4	77.9	1.7	0.02	7.6	0.88	5.42	0.63	7.88	0.6	23.6	38.3	0.01	3.5	0.43	0.28
	5 V	329.9	944.4	1.9	0.19	94.8	0.84	4.83	0.44	6.81	2.3	125.5	53.6	0.04	19	0.69	0.28
	10 V	842.1	2490.6	2.0	0.52	254	0.83	4.83	0.47	6.87	3.5	238.5	67.1	0.07	36	0.91	0.28
	20 V	2078.9	6188.4	2.0	1.30	634	0.76	3.90	0.37	6.48	6.6	380.6	56.7	0.12	58	1.09	0.28

Table 1. Comparison of the parameters between the Ga_2O_3 and $(GaMn)_2O_3$ photodetectors.

lattice. Meanwhile, the prototype photodetector devices with a MSM structure have been fabricated and investigated based on the undoped and Mn-doped Ga_2O_3 epitaxial thin films. In compare with the undoped Ga_2O_3 , the Mn-doped photodetector takes on a lower dark current, a higher sensitivity and a faster photoresponse time, which are attributed to the higher resistivity and a lower trapping states concentration of oxygen vacancies. For the pure Ga_2O_3 , there are a few oxygen vacancies as donor-type defects leading to the origin of intrinsic n-type conductivity. While for Mn-doping, the extra electrons generated by oxygen vacancies would enter the Mn *d*-shell with the change Mn valence from +3 to +2; that is, the Fermi level would be pinned mid-gap at the Mn 2+/3+ transition level, which is predicted by DFT. The study presents that doping with Mn may provide a convenient and reliable method of obtaining high insulating β -Ga $_2O_3$ thin film which is a promising candidate for use in high performance solar-blind photodetector.

Methods

The thin films were prepared on 10×10 mm α -Al₂O₃ (0001) substrates by the LMBE technique at a repetition frequency of 1 Hz and with a fluence of ~5 J/cm². The thin film deposition was grown in a vacuum environment of 1×10^{-6} Pa and at a substrate temperature of 800 °C. For the (GaMn)₂O₃ thin film, the alternating depositions of Ga₂O₃ and Mn ultrathin layers were performed for 20 times, which enables the realization of Mn-doped Ga₂O₃ due to inter diffusion between Mn and Ga₂O₃ ultrathin layers at high temperature. The Mn concentrations in (GaMn)₂O₃ thin film was determined as 28.4 at.% by XPS. More detail informations about the synthesis, characterizations, photoresponse measurements and simulation calculation can see Supplementary Information.

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Acknowledgements

The authors thank Prof. Xiaolong Chen from Research & Development Center for Functional Crystals, Beijing National Laboratory for Condensed Matter Physics, Institute of Physics, Chinese Academy of Science, for the productive suggestions of manuscript; the authors also extend thank to Mr. Xiaolong Wang from Henan

Normal University for the helpful discussions in simulation calculation. This work was supported by the National Natural Science Foundation of China (No. 51572033, 61274017, 51572241, 11404029), Beijing Natural Science Foundation (No. 2154055), the Beijing University of Posts and Telecommunications (BUPT) Excellent Ph.D. Students Foundation (CX2015304), the Fundamental Research Funds for the Central Universities (Grant No. 2014RC0906).

Author Contributions

W.T., P.L. and Z.W. designed this project. D.G. performed the thin film growths, the measurements, analysed the results, and wrote the original manuscript. L.L. and M.L. modified the manuscript. W.C. and X.Z. performed the XRD and EDS measurements respectively. All authors discussed the results and worked on the manuscript.

Additional Information

Supplementary information accompanies this paper at http://www.nature.com/srep

Competing financial interests: The authors declare no competing financial interests.

How to cite this article: Guo, D. et al. Inhibition of unintentional extra carriers by Mn valence change for high insulating devices. Sci. Rep. 6, 24190; doi: 10.1038/srep24190 (2016).

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